

**PATENT** 

## ATTORNEY DOCKET NO:

## COMBINED DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled <a href="RESISTIVE MATERIAL">RESISTIVE ELEMENT</a>, RESISTOR, AND METHOD FOR MANUFACTURING THE SAME, the specification of which

and was am X was describe	ended on	as Application d in PCT International 003 and as amended un	 Application No. <u>PC</u>	T/JP2003/16013
I hereby state the specification, including to		ewed and understand the amended by any amended		
I acknowledge t accordance with Title 37		close all information I eral Regulations, Section		to patentability in
I hereby claim to application(s) for patent designated at least one condentified below, by check PCT international applicational.	or inventor's country other the king below, a	han the United States on ny foreign application	fany PCT internation of America, listed belof for patent or inventor	nal application which ow and have also r's certificate, or of any
2002-363363	_ Japan	December 16, 2002	X	
(Application Number)	(Country)	(Filing Date)	(Priority Claimed)	(Priority Not Claimed)

I hereby appoint the following attorneys and/or agents to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith: Randolph A. Smith, Reg. No. 32,548.

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

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